PRODUCT SPECIFICATION

Product Name

S62F

LoRa Transceiver Module

Version

D

Doc No

901-12301

Date

2021/01/25



AcSiP Technology Corp.

www.acsip.com.tw

Document History

Date	Revised Contents	Revised By	Version
2020/01/17	Initial Version	PW	А
2020/03/24	Update supply current in Transmit mode	PW	В
2020/06/04	Update SiP and Tray Dimension	PW	С
2021/01/25	Modify electrical characteristics, block diagrams	Kenny	D
	and mechanical dimensions		
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1. Description

The AcSiP S62F transceiver features the LoRa[™] long range modem that provides ultra-long range spread spectrum communication and high interference immunity whilst minimizing current consumption.

S62F can achieve a sensitivity of over -137dBm using a TCXO and the related bill of materials. The high sensitivity combined with the integrated +22 dBm(max.) power amplifier yields an industry-leading link budget making it optimal for any application requiring range or robustness. LoRaTM also provides significant advantages in both blocking and selectivity over conventional modulation techniques, solving the traditional design compromise between range, interference immunity, and energy consumption.

Feature

- Small size: 9 mm x 8 mm x 1.26 mm (Typ.)
- LoRa Transceiver Module, +22 dBm Max. RF output power
- Programmable bit rate up to 62.5 kbps LoRa
- Programmable bit rate up to 300 kbps FSK
- High sensitivity: down to -137 dBm (@BW=125KHz, SF=12)
- Embedded TCXO of 32MHz



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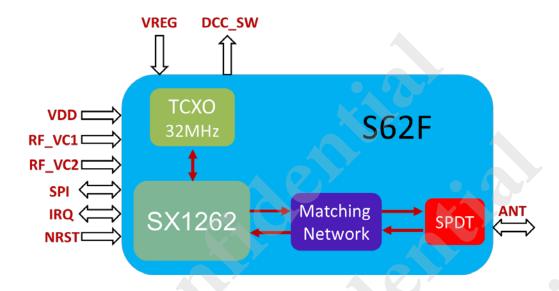
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1-1. Block Diagram

A simplified block diagram of the S62F module is depicted in the figure below.



1-2. Product Version

Part Number	Frequency Range	Spreading Factor	Bandwidth	Sensitivity (dBm)	
S62F	865MHz - 928MHz	5 - 12	7.8 - 500 kHz	- 137 @125KHz, SF12	

1-3. Specification

Technical Specifications			
Model Name	S62F		
Product Description	LoRa Transceiver Module		
Network Standard Suitable PHY for LoRaWAN			
Host Interface SPI			
Operation Conditions	•.40		
Temperature	Storage: -50° C $\sim +125^{\circ}$ C Operating: -40° C $\sim +85^{\circ}$ C Low TX Duty cycle ^(*Note) : -40° C $\sim +95^{\circ}$ C		
Humidity	■ Operating: 10 ~ 95% (Non-Condensing) ■ Storage: 5 ~ 95% (Non-Condensing)		
Dimension	9 mm x 8 mm x 1.26 mm (Typ.)		
Package	LGA type		

^{*}Note: Low power dissipation means low TX duty cycle and low GPIO driving and sinking current.



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2. Electrical Characteristics

2-1. Absolute Maximum Ratings

Symbol	Parameter	Min.	Тур.	Max.	Unit
VDD	Supply Voltage	-0.5		3.9	V
Pmr	RF Input Level			+10	dBm

2-2. Recommended Operating Range

Symbol	Parameter	Min.	Тур.	Max.	Unit
VDD	Supply Voltage	1.8	3.3	3.7	V
Тор	Temperature under bias	-40		85	°C

Note: VDD 3.3V for +22dBm , VDD 2.7 V for +20dBm , VDD 2.4 V for +19dBm

2-3. Power Consumption Specification

Symbol	Parameter	Conditions	Тур.	Max.	Unit
IDDSL	Supply current in Sleep mode	60'	0.57	0.7	μΑ
IDDSBR	Supply current in Standby RC mode	TCXO OFF	0.56		mA
IDDSBT	Supply current in Standby XOSC mode	TCXO ON	1.96		mA
IDDR	Supply current in Receive mode	RX Boosted LoRa 125kHz	5.6		mA
	. 0	RF SetPW = + 22 dBm	117	121	
IDDT	Supply current in Transmit mode with	RF SetPW = + 20 dBm	103	107	A
IDDT	impedance matching	RF SetPW = + 17 dBm	90	95	mA
	<i>y</i>	RF SetPW = + 14 dBm	80	86	



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2-4. RF Characteristics

2-4.1. Electrical Specifications

The electrical specifications are given with the following conditions unless otherwise specified:

- VDD = 3.3 V
- Temperature = 25 °C
- FRF = 868/915 MHz
- All RF impedances matched
- Transmit mode output power defined into a 50 ohm load impedance
- FSK BER = 0.1%, 2-level FSK modulation without pre-filtering, BR = 4.8 kb/s, FDA = \pm 5 kHz, BW F = 20 kHz double-sided
- LoRa® PER = 1%, packet 64 bytes, preamble 8 symbols, CR = 4/5, CRC on payload enabled
- RX/TX specifications given using default RX gain step and direct tie connection between Rx and Tx

2-4.2. Receive Mode Specifications

Symbol	Description	Conditions	Min	Тур	Max	Unit
	Concitivity 2 FCV	BR = 0.6 kb/s, FDA = 0.8 kHz, BW = 4 kHz	4	-125		
	Sensitivity 2-FSK, RX Boosted gain,	BR = 1.2 kb/s, FDA = 5 kHz, BW = 20 kHz		-123		
RXS_2FB	split RF paths for Rx and Tx,	BR = 4.8 kb/s, FDA = 5 kHz, BW = 20 kHz		-118		dBm
	RF switch insertion loss	BR = 38.4 kb/s, FDA = 40 kHz, BW = 160 kHz		-109		
	excluded	BR = 250 kb/s, FDA = 125 kHz, BW = 500 kHz		-104		
	63	BW = 125 kHz, SF = 7		-124		
	Sensitivity LoRa,	BW = 125 kHz, SF = 12		-137		
DVC LD	Rx Boosted gain , split RF paths for Rx and Tx, RF switch insertion loss excluded	- IDW = ZJU KIIZ. JI = /		-121		al Dura
KX2_LB		BW = 250 kHz, SF = 12				dBm
		BW = 500 kHz, SF = 7		-117		
		BW = 500 kHz, SF = 12		-129		
CCR_F	Co-channel rejection, FSK			-9		dB
CCD I	Co channel rejection LaDa	SF = 7		5		dB
CCR_L	Co-channel rejection, LoRa	SF = 12		19		ив
ACR_F	Adjacent channel rejection, FSK	Offset = ±50 kHz		45		dB
	Adiana dalama da di	Offset = ±1.5 x BW,				
ACR_L	Adjacent channel rejection,	BW = 125 kHz, SF = 7		60		dB
	LoRa	BW = 125 kHz, SF = 12		72		



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Symbol	Description	Conditions	Min	Тур	Max	Unit
		BR = 4.8 kb/s, FDA = 5 kHz, BW = 20 kHz				
BI_F	Blocking immunity, FSK	Offset = +/- 1 MHz		68		dB
DI_I	blocking initiality, 13k	Offset = +/- 2 MHz		70		ив
		Offset = +/- 10 MHz		80		
		BW =125 kHz, SF = 12	,			
DI I	Blocking immunity, LoRa	Offset = +/- 1 MHz		88		dB
BI_L		Offset = +/- 2 MHz		90		ив
		Offset = +/- 10 MHz		99		
	Maximum tolerated					
	frequency offset between	All bandwidths, ±25% of BW				
	transmitter and receiver, no sensitivity degradation,	The tighter limit applies (see below)	14	± 25%		BW
	SF5 to SF12					
FERR_L	Maximum tolerated					
	frequency offset between	SF12	-50		50	
		SF11	-100		100	ppm
	no sensitivity degradation, SF10 to SF12	SF10	-200		200	
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2-4.3. Transmit Mode Specifications

Symbol	Description	Conditions	Min	Тур	Max	Unit
ТХОР	Maximum RF output power	Highest power step setting		+21	+22	dBm
	RF output power drop	+22 dBm, VDD = 2.7 V		2		
TXDRP	versus supply voltage	+22 dBm, VDD = 2.4 V		3		dB
	versus supply voitage	+22 dBm, VDD = 1.8 V		6		
TXPRNG RF output power range		Programmable in 31 steps,	TXOP-31		TXOP	dBm
IXIKIVO	iti output power range	typical value	1701 31		1701	abiii
TXACC	RF output power step			± 2		dB
TAACC	accuracy			12		uв
TXRMP	Power amplifier ramping	Programmable	10		3400	μs
IAMVII	time	Togrammable	10		3400	μз
TC TV	Ty wake up time	Frequency Synthesizer enabled		* 5 + PA		ms
TS_TX	Tx wake-up time	@SF = 7		ramping		ms

^{* (5}ms + PA ramping) is verified under the condition of SF=7, the length of time will be fine-tuned by different SF conditions

2-4.4. Digital Specification

Symbol	Description	Conditions	Min	Тур	Max	Unit
VIH	Input High Voltage		0.7*VDD		VDD+0.3	V
V _{IL}	Input Low Voltage		-0.3		0.3*VDD	V
V _{IL-N}	Input Low Voltage for pin NRESET		-0.3		0.2*VDD	V
VOH	Output High Voltage	Imax = -2.5 mA	0.9*VDD		VDD	V
V _{OL}	Digital output level low	Imax = 2.5 mA	0		0.1*VDD	V
Ileak	Digital input leakage current (NSS, MOSI, SCK)		-1		1	μΑ



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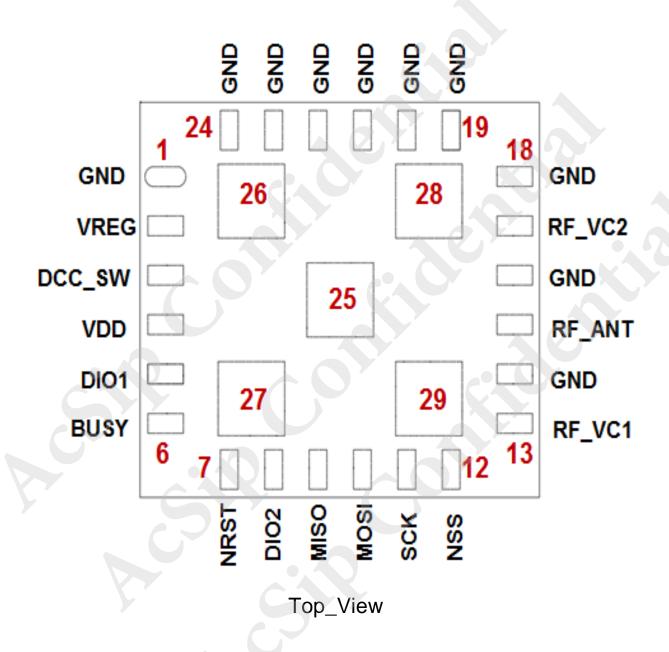
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Pin Definition

3-1. Pin Description





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Pin	Definition	I/O	Description
1	GND	-	Ground
2	VREG	I	Regulated voltage from the internal DC-DC
3	DCC_SW	0	DC-DC Switcher Output
4	VDD	I	Power supply
5	DIO1	I/O	Multi-purpose digital IO
6	BUSY	0	Busy indicator
7	NRST	I	Reset signal, active low
8	DIO2	1/0	* Multi-purpose digital IO / RF Switch control
9	MISO	0	SPI slave output
10	MOSI	1	SPI slave input
11	SCK	I	SPI clock
12	NSS	ı	SPI Slave Select
13	RF_VC1	I	RF Switch control / Active "H" Receiver
14	GND	-	Ground
15	RF_ANT	I/O	RF Input / Output
16	GND	-	Ground
17	RF_VC2	7	RF Switch control / Active "H" Transceiver
18	GND	-	Ground
19	GND	-	Ground
20	GND	-	Ground
21	GND	-	Ground
22	GND	~°^	Ground
23	GND		Ground
24	GND		Ground
25~29	EGND	-	Ground

^{*}DIO2 has a double functionality. As DIO2 can be used as a generic IRQ line and any IRQ can be routed through this pin. Also, DIO2 can be configured to drive an RF switch through the use of the command SetDio2AsRfSwitchCtrl(...). In this mode, DIO2 will be at a logical 1 during Tx and at a logical 0 in any other mode.



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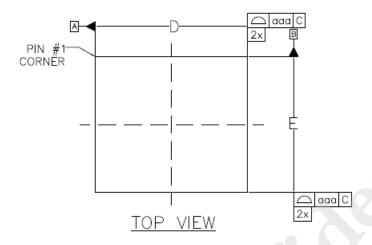
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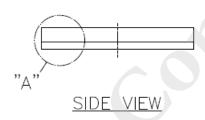
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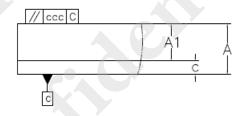
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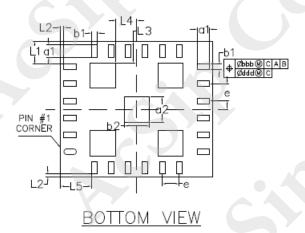
3-2. Mechanical Dimension







DETAIL : "A"



Symbol	Dimension in mm		
	MIN	MOM	MAX
A	1.19	1.26	1.31
С	0.36	0.41	0.44
A1	0.83	0.85	0.87
D	8.90	9.00	9.10
E	7.90	8.00	8.10
a 1	0.73		
b1	0.33		
a2	1.50		
b2	1.50		
е	1.00		
L1	1.335		
L2	0.20		
L3	1.25		
L4	1.25		
L5	1.835		
aaa	0,15 BSC		
bbb	0.10 BSC		
CCC	0.10 BSC		
ddd	0.05 BSC		



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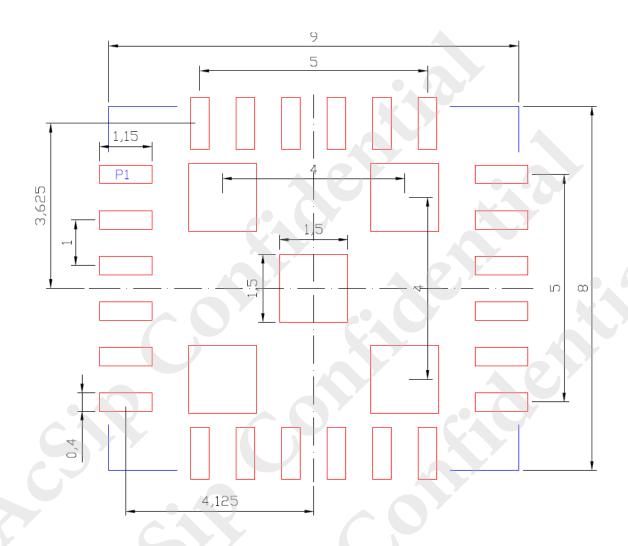
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3-3. Recommended Footprint







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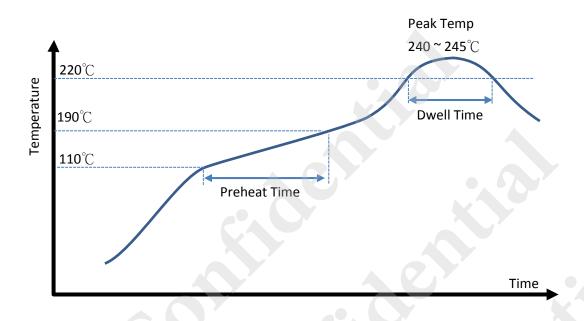
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4. Recommended Reflow Profile



Preheat time	110 ~ 190 °C : 90 ~ 120 sec	
Dwell time	above 220 °C: 50 ~ 70 sec	
Peak Temp	240 ~ 245 °C	
Ramp Up/Down Rate	Up: 1~3 °C /sec Down: 1~5 °C /sec	

The recommended reflow profile is provided as a guideline. Optimal profile may differ due to oven type, assembly layout or other process variables. Nitrogen atmosphere is strongly recommended for best soldering result.



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5. Module Preparation

5-1. Handling

Handling the module, operator must wear the anti-static wrist strap to avoid ESD damage. After each module was aligned and tested, it should be transported and stored with anti-static tray and packing. This protective package must be remained in the suitable environment until the module is assembled and soldered onto the main board. Base on reliability test result, Module passed MSL3 criterion.

5-2. SMT Preparation

- 1. Calculated shelf life in sealed bag: 6 months at <40 degree and <90% relative humidity (RH).
- 2. Peak package body temperature: 250 degree.
- 3. After bag was opened, devices that will be subjected to reflow solder or other high temperature process must be
 - A. Mounted within: 168 hours of factory conditions <30 degree / 60% RH.
 - B. Stored at $\leq 10\%$ RH with N2 flow box.
- 4. Devices require baking, before mounting process, if:
 - A. Package bag does not be kept in vacuumed while first time opening.
 - B. Humidity Indicator Card is >10% when read at 23 ± 5 degree.
 - C. Exposed at 3A condition over 8 hours or Exposed at 3B condition over 24 hours.
- 5. If baking is required, devices should be baked for 12 hours at 125 \pm 5 degree.



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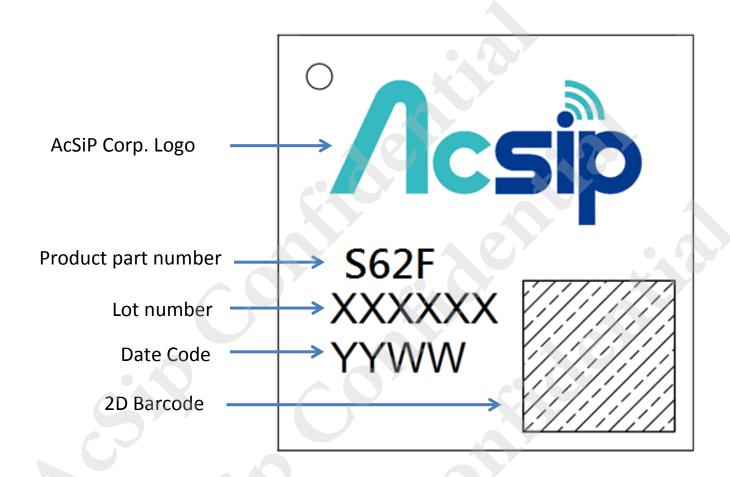
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6. Package Information

6-1. Product Marking





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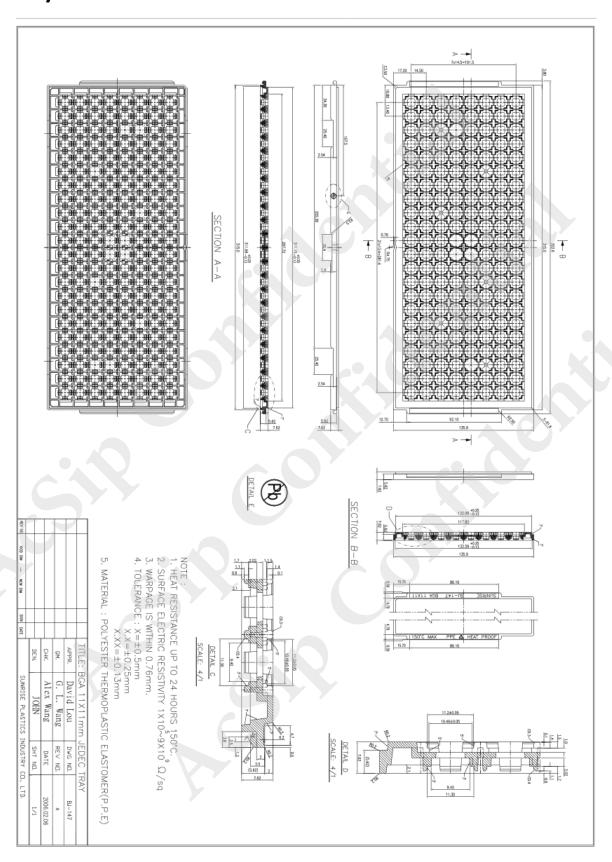
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6-2. Tray Dimension





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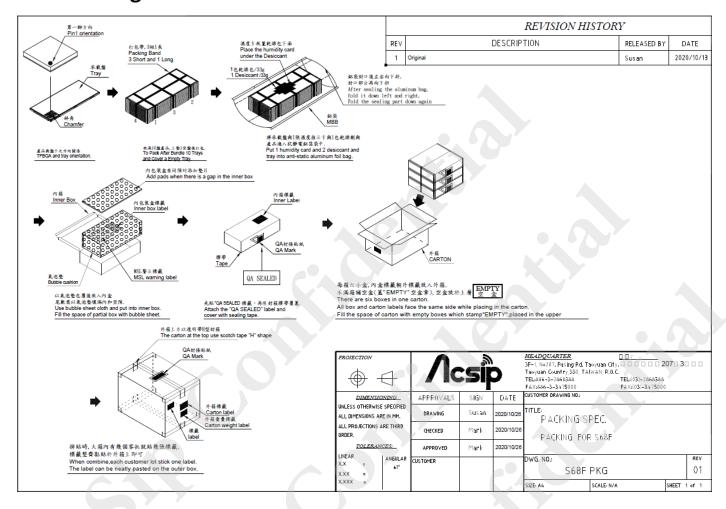
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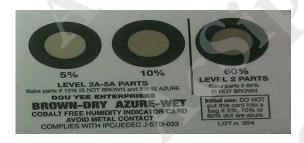
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6-3. Packing Information



6-4. Humidity Indicator Card





Dry

Indicates:

5%, 10%, 60% relative humidity

Color Change:

Brown (Dry) \rightarrow Blue (Wet)



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